



## SPECIFICATION

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**SPEC. NO.:** PS-52914-XXXXX-XXX                      **REVISION:** A

**PRODUCT NAME:** 2.54 mm Power Card Edge Conn.

**PRODUCT NO:** 52914-XXXXX-XXX

<b>PREPARED:</b>  <b>Hsu, Yi Lun</b>  <b>DATE:</b> <b>2020/07/21</b>	<b>CHECKED:</b>  <b>Chen, Chun Yuan</b>  <b>DATE:</b> <b>2020/07/21</b>	<b>APPROVED:</b>  <b>Wang, Chun Sheng</b>  <b>DATE:</b> <b>2020/07/21</b>
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**TITLE: 2.54MM POWER CARD EDGE CONN.**

RELEASE DATE: 2020/12/18

REVISION: A

ECN No: ECN-001616

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Aces P/N: 52914 series

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### 1 Revision History

Rev.	ECN #	Revision Description	Prepared	Date
A	ECN-001616	NEW PROJECT	HSU YI LUN	2020/07/21

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## 2 SCOPE

This specification covers performance, tests and quality requirements for 2.54 mm pitch POWER CARD EDGE CONN.

## 3 APPLICABLE DOCUMENTS

## 4 REQUIREMENTS

### 4.1 Design and Construction

- 4.1.1 Product shall be of design, construction and physical dimensions specified on applicable product drawing.
- 4.1.2 All materials conform to R.o.H.S. and the standard depends on TQ-WI-140101.

### 4.2 Materials and Finish

- 4.2.1 Contact: High performance copper alloy (Phosphor Bronze)
  - Finish: (a) Contact Area: Refer to the drawing.
  - (b) Under plate: Refer to the drawing.
  - (c) Solder area: Refer to the drawing.
- 4.2.2 Housing: Thermoplastic or Thermoplastic High Temp., UL94V-0

### 4.3 Ratings

- 4.3.1 Working Voltage Less than 36 Volts
- 4.3.2 Current: Rating Current is for 64 pins, each pin for 7A
- 4.3.3 Operating Temperature : -40°C to +85°C

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## 5 Performance

### 5.1. Test Requirements and Procedures Summary

Item	Requirement	Standard
Examination of Product	Product shall meet requirements of applicable product drawing and specification.	Visual, dimensional and functional per applicable quality inspection plan.
<b>ELECTRICAL</b>		
Item	Requirement	Standard
Low Level Contact Resistance	20 m $\Omega$ Max.(initial)per contact 10 m $\Omega$ Max.(finish)	Mate connectors, measure by dry circuit, 20mV Max., 100mA Max. (EIA-364-23)
Insulation Resistance	5000 M $\Omega$ Min.	Unmated connectors, apply 500 V DC between adjacent terminals. (EIA-364-21)
Dielectric Withstanding Voltage	No discharge, flashover or breakdown. Current leakage: 1 mA max.	1000 VAC Min. at sea level for 1 minute. Test between adjacent contacts of unmated connectors. (EIA-364-20)
Temperature rise	30°C Max. Change allowed	Mate connector: measure the temperature rise at rated current until temperature stable. The ambient condition is still air at 25°C (EIA-364-70,Method 1 ,Condition I )
<b>MECHANICAL</b>		
Item	Requirement	Standard
Durability	200 cycles.	The sample should be mounted in the tester and fully mated and unmated the number of cycles specified at the rate of 25.4 $\pm$ 3mm/min.  (EIA-364-09)
Mating/Unmating Forces	Mating 200gf (Max.) /Per Pin Unmating 20gf (Min.)/Per Pin	Operation Speed : 25.4 $\pm$ 3 mm/minute.. Measure the force required to mate/unmate connector.  (EIA-364-13)
Terminal / Housing Retention Force (Rcpt. CONN.)	500gf MIN.	Apply axial pull out force at the speed rate of 25.4 $\pm$ 3 mm/minute. On the terminal assembled in the housing.

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### MECHANICAL

Item	Requirement	Standard
Vibration	1 $\mu$ s Max.	The electrical load condition shall be 100 mA maximum for all contacts. Subject to a simple harmonic motion having amplitude of 0.76mm (1.52mm maximum total excursion) in frequency between the limits of 10 and 55 Hz. The entire frequency range, from 10 to 55 Hz and return to 10 Hz, shall be traversed in approximately 1 minute. This motion shall be applied for 2 hours in each of three mutually perpendicular directions. (EIA-364-28 Condition I)
Shock (Mechanical)	1 $\mu$ s Max.	Subject mated connectors to 50 G's (peak value) half-sine shock pulses of 11 milliseconds duration. Three shocks in each direction shall be applied along the three mutually perpendicular axes of the test specimen (18 shocks). The electrical load condition shall be 100mA maximum for all contacts. (EIA-364-27, test condition A)

### ENVIRONMENTAL

Item	Requirement	Standard
Resistance to Reflow Soldering Heat	See Product Qualification and Test (Lead Free)	Pre Heat : 150°C~180°C, 60~120sec. Heat : 230°C Min., 40sec Min. Peak Temp. : 260°C Max, 10sec Max.
Thermal Shock	See Product Qualification and Test Sequence Group 4	Mated Connector to follow condition for 25 cycles. 1 cycles: -55 +0/-3 °C, 30 minutes +85 +3/-0 °C, 30 minutes (EIA-364-32, Test Condition I)
Humidity	See Product Qualification and Test Sequence Group 4	Mated Connector 40°C, 90~95% RH, 96 hours. (EIA-364-31, Condition A, Method II)

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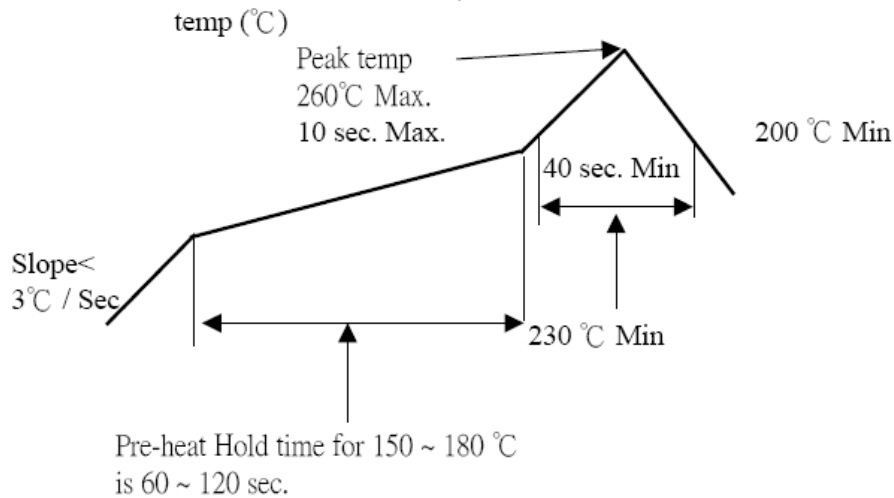
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Temperature life	See Product Qualification and Test Sequence Group 5	Mated connectors to temperature life at 105°C for 96 hours. (EIA-364-17, Test Condition A)
Salt Spray	See Product Qualification and Test Sequence Group 6	Mated connectors to 5% salt-solution concentration, 35°C Gold flash for 96 hours (EIA-364-26)
Solder ability	Tin plating: Solder able area shall have minimum of 95% solder coverage. Gold plating: Solder able area shall have minimum of 75% solder coverage	And then into solder bath, Temperature at 245 ±5°C, for 4-5 sec. (EIA-364-52)
Hand Soldering Temperature Resistance	Appearance: No damage	T ≥ 350°C, 3sec at least.

**6 INFRARED REFLOW CONDITION**

**6.1. RECOMMENDED REFLOW TEMPERATURE CONDITION**

TEMPERATURE CONDITION GRAPH  
(TEMPERATURE ON BOARD PATTERN SIDE)



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## 7 PRODUCT QUALIFICATION AND TEST SEQUENCE

Test or Examination									
	1	2	3	4	5	6	7	8	9
Examination of Product	1,3	1	1	1、7	1、6	1、4	1,3		1,3
Low Level Contact Resistance		2、6	2、5	2、8	2、7	2、5			
Insulation Resistance				3、9	3、8				
Dielectric Withstanding Voltage				4、10	4、9				
Temperature rise	2								
Mating / Unmating Forces		3、5							
Durability		4							
Vibration			3						
Shock (Mechanical)			4						
Thermal Shock				5					
Humidity				6					
Temperature life					5				
Salt Spray(Only For Gold Plating)						3			
Solder ability							2		
Terminal / Housing Retention Force (Rcpt. CONN.)								1	
Hand Soldering Temperature Resistance									2
Sample Size	4	4	4	4	4	4	4	4	4



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**8 EDGE CARD LAYOUT**

Test Board trace characterization: 5 Oz

Test PCB Thickness is 1.60 +/- 0.13mm (inclusive of two pads)

